Day : Saturday
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Inventor Name Search Result

Your Search was:

Last Name = YOGI
First Name = OSAMU

Application#	Patent#	Status	Date Filed	Title	Inventor Name 4
10484450	Not Issued	019	01/01/0001	DROPLET FORMATION METHOD OF MIXED LIQUID AND DROPLET FORMATION DEVICE OF MIXED LIQUID	YOGI, OSAMU
10344265	Not Issued	030	02/10/2003	LIQUID-CONTAINING SUBSTANCE ANALYZING DEVICE AND LIQUID-CONTAINING SUBSTANCE ANALYZING METHOD	YOGI, OSAMU
10058121	Not Issued	030	01/29/2002	MINUTE DROPLET FORMING METHOD A MINUTE DROPLET FORMING APPARATUS	YOGI, OSAMU
08496907	5614787	150	06/29/1995	METAL HALIDE LAMP HAVING HEAT DAM PORTION	YOGI , OSAMU

Inventor Search Completed: No Records to Display.

Search Another: Inventor

Last Name Yogi

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Search

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L Number	Hits	Search Text	DB	Time stamp
1	2	2949808.URPN.	USPAT	2004/02/21 05:56
2	12329	b41j003/04.ipc.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:58
3	256552	electrostatic	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:58
4	402	b41j003/04.ipc. and electrostatic	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:58
5	61097	239/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:58
6	2	(b41j003/04.ipc. and electrostatic) and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:59
75	1863	return$3 with (liquid with nozzle)	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:05
76	266	239/$.ccls. and (return$3 with (liquid with nozzle))	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:05
77	11	electrostatic and (239/$.ccls. and (return$3 with (liquid with nozzle)))	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:23
78	8246	core with nozzle	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:24
79	749	(core with nozzle) and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:24
80	28	electrostatic and ((core with nozzle) and 239/$.ccls.)	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:25
81	296	"core nozzle"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:25
83	381	239/690.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:25
84	0	("core nozzle" and 239/$.ccls.) and 239/690.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:25
85	0	("core nozzle" and 239/$.ccls.) and electrostatic	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:26
82	56	"core nozzle" and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:26
86	296	"core nozzle" with core	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:27
87	56	("core nozzle" with core) and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:27
88	98199	droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:27

89	3	"core nozzle" with droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:12
90	2	("3060429").PN.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:23
91	0	(""controlunit"").PN.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:23
92	225528	"control unit"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:24
93	104928	piezoelectric	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:24
94	1315	"pulse power supply"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:25
95	112	"control unit" and "control unit" and "pulse power supply"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:25
96	0	("control unit" and "control unit" and "pulse power supply") and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:25
97	37143	nozzle and droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:25
98	24025	nozzle same droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:26
99	1	(nozzle same droplet) and ("control unit" and "control unit" and "pulse power supply")	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:26
100	413571	nozzle	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:26
101	13	("control unit" and "control unit" and "pulse power supply") and nozzle	USPAT; US-PGPUB; EPO; JPO	2004/02/21 07:49
102	1	("5560543").PN.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:01
103	0	("83and92").PN.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:01
104	14	239/690.ccls. and "control unit"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:04
105	225	239/102.1.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:05
106	785	239/102.2.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:05
107	953	239/102.2.ccls. or 239/102.1.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:05
108	45	"control unit" and (239/102.2.ccls. or 239/102.1.ccls.)	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:06
109	98199	droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:06
110	18	("control unit" and (239/102.2.ccls. or 239/102.1.ccls.)) and droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:10

111	334	239/3.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:10
112	6	239/3.ccls. and "control unit"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:36
113	767	"saturation vapor pressure"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:37
114	0	239/3.ccls. and "saturation vapor pressure"	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:37
115	9	"saturation vapor pressure" and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:37
116	7	("2096912" | "2351819" | "2408588" | "4537360" | "4565324" | "5141163" | "5186620").PN.	USPAT	2004/02/21 08:40
-	1531	"minute droplet"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 10:59
-	8118	"electrostatic attraction"	USPAT; US-PGPUB; EPO; JPO	2004/02/18 15:23
-	19415	"pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:18
-	3	"minute droplet" and "electrostatic attraction" and "pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/17 09:20
-	149	"setback force"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 10:59
-	8118	"electrostatic attraction"	USPAT; US-PGPUB; EPO; JPO	2004/02/18 15:23
-	1	"setback force" and "electrostatic attraction"	USPAT; US-PGPUB; EPO; JPO	2004/02/18 15:23
-	9107	"electrostatic attraction"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/18 15:23
-	175	"setback force"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/18 15:24
-	1	"electrostatic attraction" and "setback force"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/18 15:24
-	1535	"minute droplet"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 10:59
-	149	"setback force"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 10:59
-	1	"minute droplet" and "setback force"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:00
-	53752	fluid with resist$4	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:00
-	32	"minute droplet" and (fluid with resist$4)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:00

-	19428	"pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:01
-	1	("minute droplet" and (fluid with resist$4)) and "pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:01
-	16	"minute droplet" and "pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:01
-	1123759	substrate	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:01
-	11	("minute droplet" and "pulse voltage") and substrate	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:03
-	1	(fluid with resist$4) and (("minute droplet" and "pulse voltage") and substrate)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:04
-	171	coffee.in.	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:04
-	61097	239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 05:58
-	36	coffee.in. and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/21 06:04
-	0	"pulse voltage" and (coffee.in. and 239/$.ccls.)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:06
-	1	substrate and (coffee.in. and 239/$.ccls.)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:12
-	52	("2729191" | "2945443" | "3096762" | "3131131" | "3232292" | "3456646" | "3837573" | "3897905" | "3958959" | "4043331" | "4073002" | "4150644" | "4186886" | "4198781" | "4203398" | "4266721" | "4356528" | "4380786" | "4439980" | "4467961" | "4476515" | "4508265" | "4509694" | "4549243" | "4565736" | "4657793" | "4659012" | "4671289" | "4703891" | "4735364" | "4748043" | "4749125" | "4779515" | "4801086" | "4830872" | "4846407" | "4962885" | "4979680" | "5044564" | "5086972" | "5115971" | "5180288" | "5222663" | "5267555" | "5381789" | "5402945" | "5409162" | "5483953" | "5655517" | "5712137" | "5930061" | "6039972").PN.	USPAT	2004/02/20 11:08
-	1315	"pulse power supply"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:12
-	20487	"pulse power supply" or "pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:12
-	98199	droplet	USPAT; US-PGPUB; EPO; JPO	2004/02/21 08:06
-	413571	nozzle	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:13
-	562	droplet and nozzle and ("pulse power supply" or "pulse voltage")	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:13
-	308	(droplet and nozzle and ("pulse power supply" or "pulse voltage")) and substrate	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:16
-	7	239/$.ccls. and ((droplet and nozzle and ("pulse power supply" or "pulse voltage")) and substrate)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:14

-	29	((droplet and nozzle and ("pulse power supply" or "pulse voltage")) and substrate) and (fluid with resist$4)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:17
-	1	((droplet and nozzle and ("pulse power supply" or "pulse voltage")) and substrate) and "setback force"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:17
-	2	"setback force" and (fluid with resist$4)	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:18
-	0	"setback force" and 239/$.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:18
-	19428	"pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:19
-	27	239/$.ccls. and "pulse voltage"	USPAT; US-PGPUB; EPO; JPO	2004/02/20 11:45
-	1	DE-2949808-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/20 11:56
-	1704	b05b005/00.ipc.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/20 11:57
-	3	b05b005/00.ipc. and "pulse voltage"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/20 11:58
-	2139	b41j002/06.ipc.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/20 11:58
-	4	b05b005/00.ipc. and b41j002/06.ipc.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/21 05:57